

Series 517 / 614

Pin grid array sockets and carrier with interstitial contact rows Solder tail

Pin grid array sockets with interstitial contact rows

These sockets of a very compact design have interstitial contact rows with a staggered contact arrangement and row distances of 1.27 mm. Their contact density is nearly double as compared to PGAs based on a standard 2.54 mm grid pattern

They are equipped with machined precision contacts with extrasoft contact clips assuring low insertion/withdrawal forces

Insertion characteristics: 6-finger very low

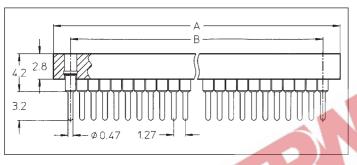
Platings	Sleeve DD	Clip 📭	Pin ←□□□─
91 93 97	5 μm Sn 5 μm Sn 5 μm Sn	0.25 μm Au 0.75 μm Au Goldflash	

Ordering information

Replace xxx-xxx with number of poles, body size and layout numbers as indicated on pages 91 and 92. For example, a 18×18 pin configuration with 17×17 interstitial rows and standard soldering tails becomes: 517-93-**391-18-101**111

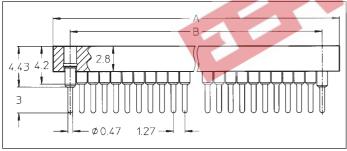
Options:

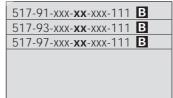
For other sizes and layouts please consult





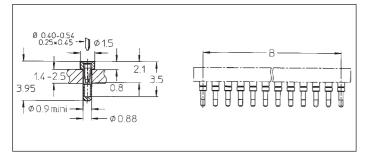
PGA sockets with interstitial rows and standard solder tails, length





Interstitial PGA socket with standard solder tails and 4 elevating contacts located at the corners for better soldering and cleaning

Add 50 to the fourth group of figures in standard reference number, e.g. 517-93-391-18-101111 becomes 517-93-391-68-101111



614-91-xxx-xx-xxx-144	В
614-93-xxx-xx-xxx-144	В
614-97-xxx-xx-xxx-144	В

PGA carrier socket with disposable plastic body and carrier pins. Low profile ultra thin contacts are plugged-on

Solder terminations Ø 0.88 mm total length of contact 3.9 mm Requires Ø min. 0.9 mm holes in PCB